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CCD SIGNAL PROCESSOR FOR SCANNER APPLICATIONS

FEATURES

- INTEGRATED TRIPLE-CORRELATED DOUBLE SAMPLER
- OPERATION MODE SELECTABLE:
 1-Channel, 3-Channel CCD Mode, 8Msps
- PROGRAMMABLE GAIN AMPLIFIER: 0dB to +13dB
- SELECTABLE OUTPUT MODES: Normal/Demultiplexed
- OFFSET CONTROL RANGE: ±500mV
- +3V, +5V Digital Output
- LOW POWER: 300mW (typ)
- **LQFP-48 SURFACE-MOUNT PACKAGE**

DESCRIPTION

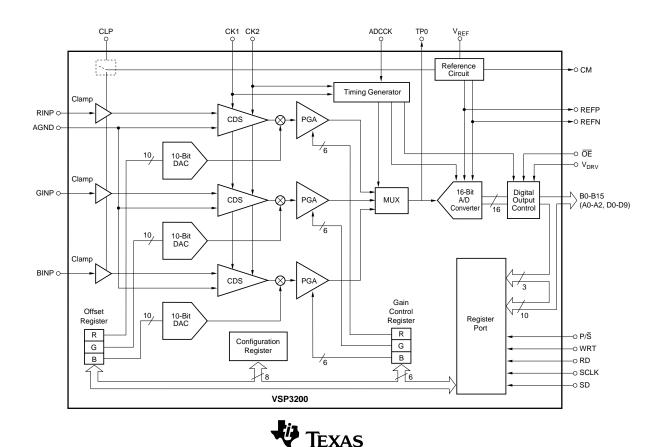
The VSP3200 and VSP3210 are complete CCD image processors that operate from single +5V supplies.

This complete image processor includes three Correlated Double Samplers (CDSs) and Programmable Gain Amplifiers (PGAs) to process CCD signals.

The VSP3200 is interface compatible with the VSP3210, which is a 16-bit, one-chip product.

The VSP3210 is pin-to-pin compatible with VSP3100, when in demultiplexed output mode.

The VSP3200 and VSP3210 can be operated from 0°C to +85°C, and are available in LQFP-48 packages.



INSTRUMENTS

SPECIFICATIONS

At $T_A = 25^{\circ}\text{C}$, $V_{CC} = +5.0\text{V}$, $V_{DRV} = +3.0\text{V}$, Conversion Rate (f_{ADCCK}) = 6MHz, $f_{CK1} = 2$ MHz, $f_{CK2} = 2$ MHz, PGA Gain = 1, normal output mode, no output load, unless otherwise specified.

			VSP3200Y VSP3210Y		
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
RESOLUTION			16		Bits
CONVERSION CHARACTERISTICS					
1-Channel CCD Mode, Max				8	MHz
3-Channel CCD Mode, Max				8	MHz
DIGITAL INPUTS					
Logic Family			CMOS		
Convert Command	Start Conversion	Risin	g Edge of ADCCK		
High-Level Input Current (V _{IN} = V _{CC}) Low-Level Input Current (V _{IN} = 0V)				20 20	μA μA
Positive-Going Threshold Voltage				2.20	V
Negative-Going Threshold Voltage		0.80		2.20	v
Input Limit		AGND - 0.3		V _{CC} + 0.3	V
Input Capacitance			5		pF
ANALOG INPUTS					
Full-Scale Input Range		0.5		3.5	Vp-p
Input Capacitance			10		pF
Input Limits		AGND - 0.3		V _{CC} + 0.3	V
External Reference Voltage Range		0.25		1.75	V
Reference Input Resistance			800		Ω
DYNAMIC CHARACTERISTICS					1.00
Integral Non-Linearity (INL)	$V_{IN} = 500 \text{mV} (V_{REF} = 1.0 \text{V})$		±8 ±1.5		LSB LSB
Differential Non-Linearity (DNL) No Missing Codes	PGA Gain = 0dB, Input Grounded		Guaranteed		LSB
Output Noise	TON Gain = Gab, input Grounded		8.0		LSBs rms
PSRR	V _{CC} = +5V, ±0.25V		0.04		% FSR
DC ACCURACY	VCC = 101, 10.201		0.01		70 1 011
Zero Error			0.8		% FS
Gain Error			1.5		% FS
Offset Control Range	10-Bit Control DAC				
	Output Voltage Range		±500		mV
DIGITAL OUTPUTS					
Logic Family			CMOS		
Logic Coding			Straight Binary		
Digital Data Output Rate, Max	Normal Mode	8			MHz
V Cupply Banga	Demultiplexed Mode	8 +2.7		+5.3	MHz V
V _{DRV} Supply Range Output Voltage, V _{DRV} = +5V		+2.7		+5.3	V
Low Level	I _{OL} = 50μA			+0.1	V
High Level	I _{OH} = 50μA	+4.6		10.1	V
Low Level	I _{OL} = 1.6mA			+0.4	V
High Level	$I_{OH} = 0.5 \text{mA}$	+2.4			V
Output Voltage, $V_{DRV} = +3V$					
Low Level	$I_{OL} = 50\mu A$			+0.1	V
High Level	$I_{OH} = 50\mu A$	+2.5			V
Output Enable Time	Output Enable = LOW		20	40	ns
3-State Enable Time Output Capacitance	Output Enable = HIGH		2 5	10	ns pF
Output Capacitance Data Latency			8		Clock Cycles
Data Cutput Delay	C _L = 15pF			12	ns
POWER-SUPPLY REQUIREMENTS	- :				
Supply Voltage: V _{CC}		4.7	5	5.3	V
Supply Current: I _{CC} (No Load)	3-Ch CCD Mode		70		mA
	1-Ch CCD Mode		60		mA
Power Dissipation (No Load)	3-Ch CCD Mode		350		mW
TEMPERATURE RANGE	1-Ch CCD Mode		300		mW
TEMPERATURE RANGE Operation Temperature	LQFP-48	0		+85	°C
	θ_{JA}	U	100	+00	°C/W



ABSOLUTE MAXIMUM RATINGS(1)

Supply Voltage: V _{CC} , V _{DRV} . Supply Voltage Differences: Among V _{CC} . GND Voltage Differences: Among GNDA. Digital Input Voltage	±0.1V ±0.1V 3V to (V _{CC} + 0.3V) 3V to (V _{CC} + 0.3V) ±10mA -40°C to +125°C -55°C to +125°C
· · · · · · · · · · · · · · · · · · ·	-55°C to +125°C +150°C +260°C

NOTE: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽¹⁾	TRANSPORT MEDIA
VSP3200Y	LQFP-48	340	0°C to +85°C	VSP3200Y	VSP3200Y VSP3200Y/2K	250-Piece Tray Tape and Reel
VSP3210Y	LQFP-48	340 "	0°C to +85°C	VSP3210Y "	VSP3210Y VSP3210Y/2K	250-Piece Tray Tape and Reel

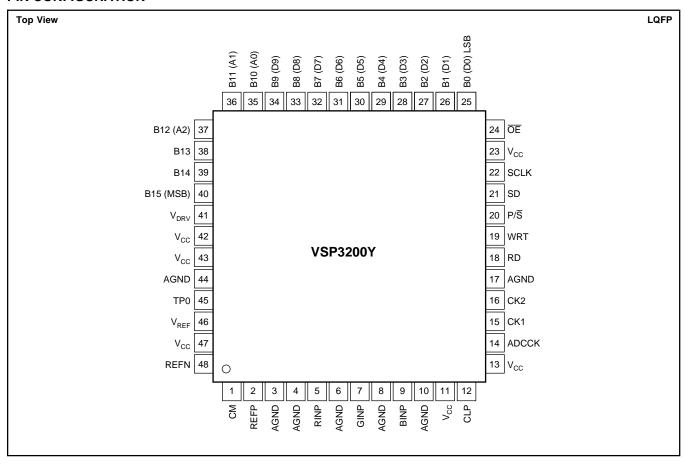
NOTE: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K indicates 2000 devices per reel). Ordering 2000 pieces of "VSP3200Y/2K" will get a single 2000-piece Tape and Reel.

DEMO BOARD ORDERING INFORMATION

PRODUCT	PACKAGE
VSP3200Y	DEM-VSP3200Y



PIN CONFIGURATION

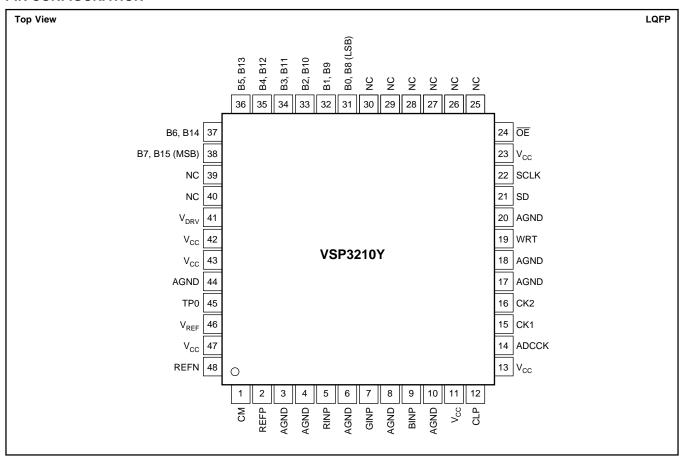


PIN DESCRIPTIONS (VSP3200Y)

PIN	DESIGNATOR	TYPE	DESCRIPTION	PIN	DESIGNATOR	TYPE	DESCRIPTION
1	СМ	AO	Common-Mode Voltage	29	B4 (D4)	DIO	A/D Output (Bit 4) and Register Data (D4)
2	REFP	AO	Upper-Level Reference	30	B5 (D5)	DIO	A/D Output (Bit 5) and Register Data (D5)
3	AGND	Р	Analog Ground	31	B6 (D6)	DIO	A/D Output (Bit 6) and Register Data (D6)
4	AGND	Р	Analog Ground	32	B7 (D7)	DIO	A/D Output (Bit 7) and Register Data (D7)
5	RINP	Al	Red Channel Analog Input	33	B8 (D8)	DIO	A/D Output (Bit 8) and Register Data (D8)
6	AGND	Р	Analog Ground		B0 LSB	DO	A/D Output (Bit 0) when Demultiplexed Output Mode
7	GINP	Al	Green Channel Analog Input	34	B9 (D9)	DIO	A/D Output (Bit 9) and Register Data (D9)
8	AGND	Р	Analog Ground		B1	DO	A/D Output (Bit 1) when Demultiplexed Output Mode
9	BINP	Al	Blue Channel Analog Input	35	B10 (A0)	DIO	A/D Output (Bit 10) and Register Address (A0)
10	AGND	Р	Analog Ground		B2	DO	A/D Output (Bit 2) when Demultiplexed Output Mode
11	V _{cc}	Р	Analog Power Supply, +5V	36	B11 (A1)	DIO	A/D Output (Bit 11) and Register Address (A1)
12	CLP	DI	Clamp Enable		B3	DO	A/D Output (Bit 3) when Demultiplexed Output Mode
			HIGH = Enable, LOW = Disable	37	B12 (A2)	DIO	A/D Output (Bit 12) and Register Address (A2)
13	V _{CC}	Р	Analog Power Supply, +5V		B4	DO	A/D Output (Bit 4) when Demultiplexed Output Mode
14	ADČČK	DI	Clock for A/D Converter Digital Data Output	38	B13	DO	A/D Output (Bit 13)
15	CK1	DI	Sample Reference Clock		B5	DO	A/D Output (Bit 5) when Demultiplexed Output Mode
16	CK2	DI	Sample Data Clock	39	B14	DO	A/D Output (Bit 14)
17	AGND	Р	Analog Ground		B6	DO	A/D Output (Bit 6) when Demultiplexed Output Mode
18	RD	DI	Read Signal for Registers	40	B15 MSB	DO	A/D Output (Bit 15)
19	WRT	DI	Write Signal for Registers		B7 MSB	DO	A/D Output (Bit 7) when Demultiplexed Output Mode
20	P/S	DI	Parallel/Serial Port Select	41	V_{DRV}	Р	Digital Output Driver Power Supply
			HIGH = Parallel Port, LOW = Serial Port	42	V _{cc}	Р	Analog Power Supply, +5V
21	SD	DI	Serial Data Input	43	V _{CC}	Р	Analog Power Supply, +5V
22	SCLK	DI	Serial Data Shift Clock	44	AGND	Р	Analog Ground
23	V _{CC}	Р	Analog Power Supply, +5V	45	TP0	AO	A/D Converter Input Monitor Pin (single-ended output)
24	V _{cc} OE	DI	Output Enable	46	V_{REF}	AIO	Reference Voltage Input/Output
25	B0 (D0) LSB	DIO	A/D Output (Bit 0) and Register Data (D0)				INT Ref: Bypass to GND with 0.1µF
26	B1 (D1)	DIO	A/D Output (Bit 1) and Register Data (D1)				EXT Ref: Input Pin for Ref Voltage
27	B2 (D2)	DIO	A/D Output (Bit 2) and Register Data (D2)	47	V _{cc}	Р	Analog Power Supply, +5V
28	B3 (D3)	DIO	A/D Output (Bit 3) and Register Data (D3)	48	REFN	AO	Lower-Level Reference



PIN CONFIGURATION



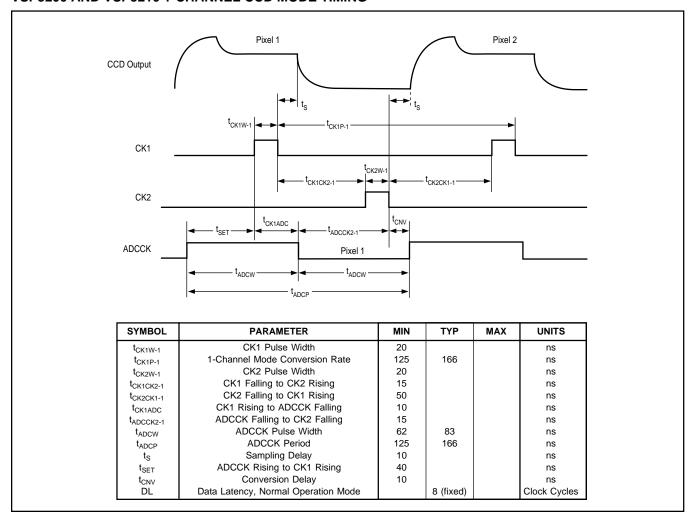
PIN DESCRIPTIONS (VSP3210Y)

PIN	DESIGNATOR	TYPE	DESCRIPTION	PIN	DESIGNATOR	TYPE	DESCRIPTION
1	CM	AO	Common-Mode Voltage	30	NC	-	Should Be Left OPEN
2	REFP	AO	Upper-Level Reference	31	B0 LSB	DO	A/D Output (Bit 0) LSB
3	AGND	Р	Analog Ground		B8	DO	A/D Output (Bit 8)
4	AGND	Р	Analog Ground	32	B1	DO	A/D Output (Bit 1)
5	RINP	Al	Red Channel Analog Input		B9	DO	A/D Output (Bit 9)
6	AGND	Р	Analog Ground	33	B2	DO	A/D Output (Bit 2)
7	GINP	Al	Green Channel Analog Input		B10	DO	A/D Output (Bit 10)
8	AGND	Р	Analog Ground	34	B3	DO	A/D Output (Bit 3)
9	BINP	Al	Blue Channel Analog Input		B11	DO	A/D Output (Bit 11)
10	AGND	Р	Analog Ground	35	B4	DO	A/D Output (Bit 4)
11	V _{CC}	Р	Analog Power Supply, +5V		B12	DO	A/D Output (Bit 12)
12	CLP	DI	Clamp Enable	36	B5	DO	A/D Output (Bit 5)
			HIGH = Enable, LOW = Disable		B13	DO	A/D Output (Bit 13)
13	V _{CC}	Р	Analog Power Supply, +5V	37	B6	DO	A/D Output (Bit 6)
14	ADCCK	DI	Clock for A/D Converter Digital Data Output		B14	DO	A/D Output (Bit 14)
15	CK1	DI	Sample Reference Clock	38	В7	DO	A/D Output (Bit 7)
16	CK2	DI	Sample Data Clock		B15 MSB	DO	A/D Output (Bit 15) MSB
17	AGND	Р	Analog Ground	39	NC	-	Should Be Left OPEN
18	AGND	Р	Analog Ground	40	NC	-	Should Be Left OPEN
19	WRT	DI	Write Signal for Registers	41	V_{DRV}	Р	Digital Output Driver Power Supply
20	AGND	Р	Analog Ground	42	V _{cc}	Р	Analog Power Supply, +5V
21	SD	DI	Serial Data Input	43	V _{CC}	Р	Analog Power Supply, +5V
22	SCLK	DI	Serial Data Shift Clock	44	AGND	Р	Analog Ground
23	V _{CC}	Р	Analog Power Supply, +5V	45	TP0	AO	A/D Converter Input Monitor Pin (single-ended output)
24	V _{CC} OE	DI	Output Enable	46	V_{REF}	AIO	Reference Voltage Input/Output
25	NC	-	Should Be Left OPEN				INT Ref: Bypass to GND with 0.1µF
26	NC	-	Should Be Left OPEN				EXT Ref: Input Pin for Ref Voltage
27	NC	-	Should Be Left OPEN	47	V _{cc}	Р	Analog Power Supply, +5V
28	NC	_	Should Be Left OPEN	48	REFN	AO	Lower-Level Reference
29	NC	-	Should Be Left OPEN				

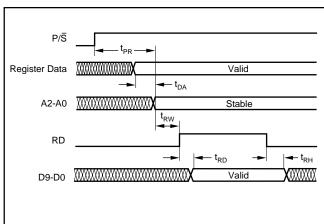


TIMING SPECIFICATIONS

VSP3200 AND VSP3210 1-CHANNEL CCD MODE TIMING



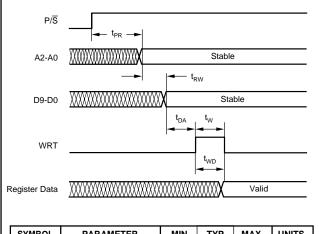
VSP3200 TIMING FOR PARALLEL PORT READING



SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS
t _{PR}	Parallel Ready Time	20			ns
t _{DA}	Data Setup Time	30	50		ns
t _{RW}	Address Setup Time	20	50		ns
t _{RD}	Read Out Delay			20	ns
t _{RH}	Data Hold Time			1	ns

NOTES: (1) This feature is for the VSP3200 only. (2) Reading out register data through the serial port is prohibited.

VSP3200 TIMING FOR PARALLEL PORT WRITING

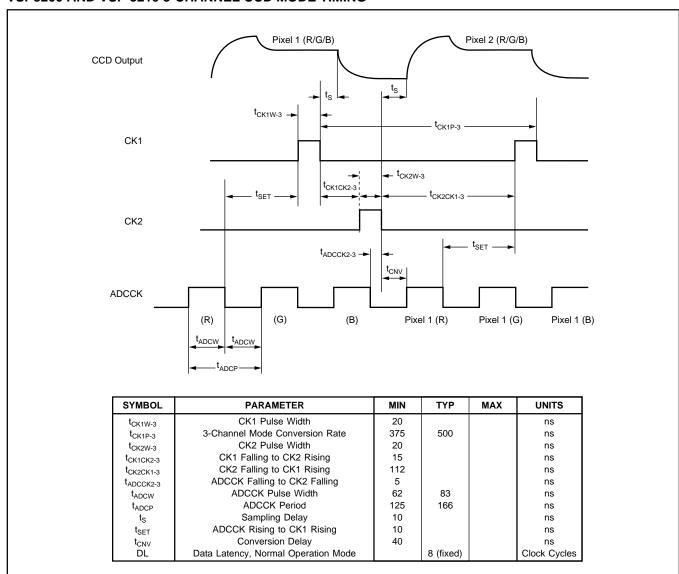


PARAMETER	MIN	TYP	MAX	UNITS
Parallel Ready Time	20			ns
WRT Pulse Width	30	50		ns
Data Valid Time			30	ns
Address Setup Time	20	50		ns
Data Setup Time	30	50		ns
	Parallel Ready Time WRT Pulse Width Data Valid Time Address Setup Time	Parallel Ready Time 20 WRT Pulse Width 30 Data Valid Time Address Setup Time 20	Parallel Ready Time 20 WRT Pulse Width 30 50 Data Valid Time Address Setup Time 20 50	Parallel Ready Time 20 WRT Pulse Width 30 50 Data Valid Time 30 30 Address Setup Time 20 50

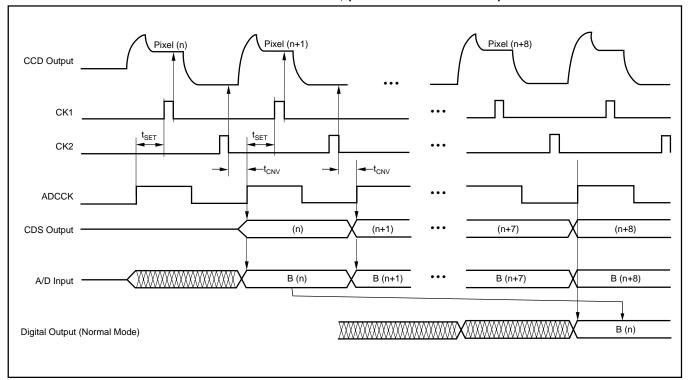
NOTE: (1) This feature is for the VSP3200 only.



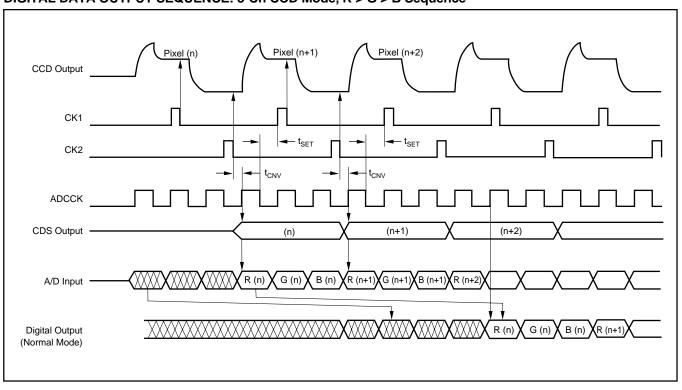
VSP3200 AND VSP 3210 3-CHANNEL CCD MODE TIMING



DIGITAL DATA OUTPUT SEQUENCE: 1-Ch CCD Mode, (B-Ch: D4 = 1 and D5 = 0)

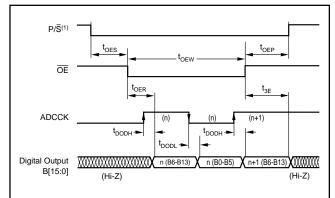


DIGITAL DATA OUTPUT SEQUENCE: 3-Ch CCD Mode, R > G > B Sequence





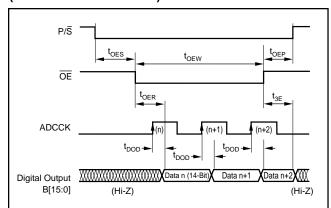
VSP3200 AND VSP3210 TIMING FOR DIGITAL DATA OUT-PUT (DEMULTIPLEXED OUTPUT MODE)



SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS
t _{OES}	A/D Output Enable Setup Time	20			ns
t _{OER}	Output Enable Time		20	40	ns
t _{3E}	3-State Enable Time		2	10	ns
t _{OEW}	OE Pulse Width	100			ns
t _{DODH}	Digital Data Output Delay, High-Byte			12	ns
t _{DODL}	Digital Data Output Delay, Low-Byte			12	ns
t _{OEP}	Parallel Port Setup Time	10			ns

NOTES: (1) The VSP3210 has no P/ \overline{S} signal; t_{OES} and t_{OEP} specs. are not needed. (2) When in inhibit operation mode, \overline{OE} sets LOW during P/ \overline{S} = HIGH period.

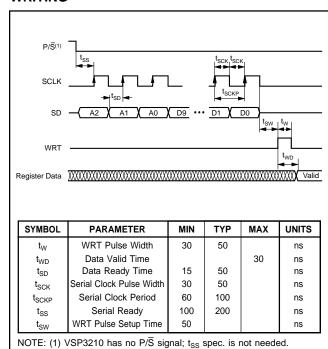
VSP3200 TIMING FOR DIGITAL DATA OUTPUT (NORMAL OUTPUT MODE)



SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS
t _{OES}	A/D Output Enable Setup Time	20			ns
t _{OER}	Output Enable Time		20	40	ns
t _{3E}	3-State Enable Time		2	10	ns
t _{OEW}	OE Pulse Width	100			ns
t _{DOD}	Digital Data Output Delay			12	ns
t _{OEP}	Parallel Port Setup Time	10			ns

NOTES: (1) This feature is for the VSP3200 only. (2) When in inhibit operation mode, $\overline{\text{OE}}$ sets LOW during P/ $\overline{\text{S}}$ = HIGH period.

VSP3200 AND VSP3210 TIMING FOR SERIAL PORT WRITING



THEORY OF OPERATION

INTRODUCTION

The VSP3200 and VSP3210 are complete mixed-signal ICs that contain all of the key features associated with the processing of the CCD line sensor output signal in scanners, photo copiers, and similar applications. See the simplified block diagram on page 1 for details. The VSP3200 and VSP3210 include Correlated Double Samplers (CDSs), Programmable Gain Amplifiers (PGAs), Multiplexer (MUX), Analog-to-Digital (A/D) converter, input clamp, offset control, serial interface, timing control, and reference control generator.

The VSP3200 and VSP3210 can be operated in one of the following two modes:

- · 1-Channel CCD mode
- 3-Channel CCD mode

1-CHANNEL CCD MODE

In this mode, the VSP3200 and VSP3210 process only one CCD signal (D3 of the Configuration Register sets to "1"). The CCD signal is AC-coupled to RINP, GINP, or BINP (depending on D4 and D5 of the Configuration Register). The CLP signal enables internal biasing circuitry to clamp this input to a proper voltage, so that internal CDS circuitry can work properly. The VSP3200 and VSP3210 inputs may be applied as DC-coupled inputs, which needs to be level-shifted to a proper DC level.

The CDS takes two samples of the incoming CCD signals: the CCD reset signal is taken on the falling edge of CK1, and the CCD information is taken on the falling edge of CK2. These two samples are then subtracted by the CDS and the result is stored as a CDS output.

In the 1-Channel CCD mode, only one of the three channels is enabled. Each channel consists of a 10-bit offset Digital-to-Analog Converter (DAC) with a range from –500mV to +500mV. A 3-to-1 analog MUX is inserted between the CDSs and a high-performance, 16-bit A/D converter. The outputs of the CDSs are then multiplexed to the A/D converter for digitization. The analog MUX is not cycling between channels in this mode. Instead, it is connected to a specific channel, depending on the contents of D4 and D5 in the Configuration Register.

The VSP3200 allows two types of output modes:

- Normal (D7 of Configuration Register sets to "0").
- Demultiplexed (D7 of Configuration Register sets to "1").

The VSP3210 allows one type of output mode:

• Demultiplexed (D7 of Configuration Register sets to "1").

As specified in the "1-Channel CCD Mode" timing diagram, the rising edge of CK1 must be in the HIGH period of ADCCK, and at the same time, the falling edge of the CK2 must be in the LOW period of ADCCK. Otherwise, the VSP3200 and VSP3210 will not function properly.

3-CHANNEL CCD MODE

In the 3-Channel CCD mode, the VSP3200 and VSP3210 can simultaneously process triple output CCD signals. CCD signals are AC coupled to the RINP, GINP, and BINP inputs. The CLP signal enables internal biasing circuitry to clamp these inputs to a proper voltage so that internal CDS circuitry can work properly. The VSP3200 and VSP3210 inputs may be applied as DC-coupled inputs, which need to be level-shifted to a proper DC level.

The CDSs take two samples of the incoming CCD signals: the CCD reset signals are taken on the falling edge of CK1, and the CCD information is taken on the falling edge of CK2. These two samples are then subtracted by the CDSs and the results are stored as a CDS output.

In this mode, three CDSs are used to process three inputs simultaneously. Each channel consists of a 10-bit Offset DAC (range from –500mV to +500mV). A 3-to-1 analog MUX is inserted between the CDSs and a high-performance, 16-bit A/D converter. The outputs of the CDSs are then multiplexed to the A/D converter for digitization. The analog MUX is switched at the falling edge of CK2, and can be programmed to cycle between the Red, Green, and Blue channels. When D6 of the Configuration Register sets to "0", the MUX sequence is Red > Green > Blue. When D6 of the Configuration Register sets to "1", the MUX sequence is Blue > Green > Red.

MUX resets at the falling edge of CK1. In the case of a Red > Green > Blue sequence, it resets to "R", and in the case of a Blue > Green > Red sequence, it resets to "B".

The VSP3200 allows two types of output modes:

- Normal (D7 of Configuration Register sets to "0").
- Demultiplexed (D7 of Configuration Register sets to "1").
- The VSP3210 allows one type of output mode:

• Demultiplexed (D7 of Configuration Register sets to "1"). As specified in the "3-Channel CCD Mode" timing diagram, the falling edge of CK2 must be in the LOW period of ADCCK. If the falling edge of CK2 is in the HIGH period of ADCCK (in the timing diagram, ADCCK for sampling B-channel), the VSP3200 and VSP3210 will not function properly.

DIGITAL OUTPUT FORMAT

See Table I for the Digital Output Format. The VSP3200 and VSP3210 can be operated in one of the following two digital output modes:

- Normal output.
- Demultiplexed (B15-based Big Endian Format).

In Normal mode, the VSP3200 outputs the 16-bit data by B0 (pin 25) through B15 (pin 40) simultaneously.

In Demultiplexed mode, the VSP3200 outputs the high byte (upper 8 bits) by B8 (pin 33) through B15 (pin 40) at the rising edge of ADCCK HIGH, then outputs the low byte (lower 8 bits) by B8 (pin 33) through B15 (pin 40) at the falling edge of ADCCK.



The VSP3210 can be operated in Demultiplexed mode as the digital output (B13-based Big Endian Format), as shown in Table I. The VSP3210 outputs the high byte (upper 8 bits) by pin 31 through pin 38 at the rising edge of ADCCK HIGH, then outputs the low byte (lower 8 bits) by pin 31 through pin 38 at the falling edge of ADCCK (as shown in Table II). An 8-bit interface can be used between the VSP3200 and the Digital Signal Processor, allowing for a low-cost system solution.

DIGITAL OUTPUTS

The digital outputs of the VSP3200 and VSP3210 are designed to be compatible with both high-speed TTL and CMOS logic families. The driver stage of the digital outputs is supplied through a separate supply pin, V_{DRV} (pin 41), which is not connected to the analog supply pins (V_{CC}). By adjusting the voltage on V_{DRV} , the digital output levels will vary respectively. Thus, it is possible to operate the VSP3200 and VSP3210 on +5V analog supplies while interfacing the digital outputs to 3V logic. It is recommended to keep the capacitive loading on the data lines as low as possible (typically less than 15pF). Larger capacitive loads demanding higher charging current surges can feed back to the analog portion of the VSP3200 and VSP3210 and influence the performance. If necessary, external buffers or latches may be used, providing the added benefit of isolating the

VSP3200 and VSP3210 from any digital noise activities on the bus coupling back high-frequency noise. In addition, resistors in series with each data line may help minimize the surge current. Their use depends on the capacitive loading seen by the converter. As the output levels change from LOW to HIGH and HIGH to LOW, values in the range of 100Ω to 200Ω will limit the instantaneous current the output stage has to provide for recharging the parasitic capacitances.

PROGRAMMABLE GAIN AMPLIFIER (PGA)

The VSP3200 and VSP3210 have one PGA which is inserted between the CDSs and the 3:1 MUX. The PGA is controlled by a 6-bit of Gain Register; each channel (Red, Green, and Blue) has its own Gain Register.

The gain varies from 1 to 4.8 (0dB to 14dB), and the curve has log characteristics. Gain Register Code all "0" corresponds to minimum gain, and Code all "1" corresponds to maximum gain.

The transfer function of the PGA is:

$$Gain = 80/(80 - GC)$$

where, GC is the integer representation of the 6-bit PGA gain register.

Figure 1 shows the PGA transfer function plots.

PIN	40	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25
High Byte	B15	B14	B13	B13	B11	B10	В9	B8	Low							
Low Byte	В7	B6	B5	B4	В3	B2	B1	В0	Low							

TABLE I. Output Format for VSP3200 (Demultiplexed Mode).

PIN	40	39	38	37	36	35	34	33	32	31	30	29	28	27	26	25
High Byte	-	-	B15	B14	B13	B12	B11	B10	В9	B8	-	-	-	-	-	-
Low Byte	_	_	В7	В6	B5	B4	В3	B2	B1	B0	-	-	_	-	-	_

TABLE II. Output Format for VSP3210.

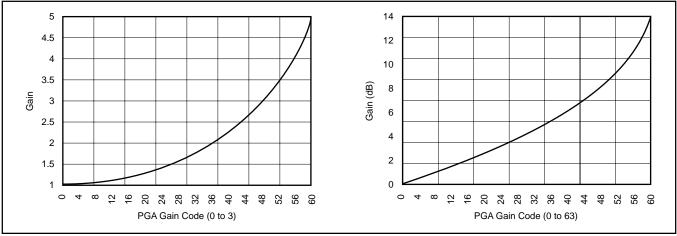


FIGURE 1. PGA Transfer Function Plots.



INPUT CLAMP

The input clamp should be used for 1-Channel and 3-Channel CCD mode, and enabled when both CLP and CK1 are set to HIGH.

Bit Clamp: the input clamp is always enabled.

Line Clamp: enables during the dummy pixel interval at every horizontal line, and disables during the effective pixel interval.

Generally, "Bit Clamp" is used for many scanner applications, however "Line Clamp" is used instead of "Bit Clamp" when the clamp noise is impressive.

CHOOSING THE AC INPUT COUPLING CAPACITORS

The purpose of the Input Coupling Capacitor is to isolate the DC offset of the CCD array from affecting the VSP3200 and VSP3210 input circuitry. The internal clamping circuitry is used to restore the necessary DC bias to make the VSP3200 and VSP3210 input circuitry functional. Internal clamp voltage, V_{CLAMP} , is set when both the CLP pin and CK1 are set HIGH. V_{CLAMP} changes depending on the value of V_{REF} . V_{CLAMP} is 2.5V if V_{REF} is set to 1V (D1 of the Configuration Register set to "0"), and V_{CLAMP} is 3V if V_{REF} is set to 1.5V (D1 of the Configuration Register set to "1").

There are many factors that decide what size of Input Coupling Capacitor is needed. Those factors are CCD signal swing, voltage difference between the Input Coupling Capacitor, leakage current of the VSP3200 and VSP3210 input circuitry, and the time period of CK1.

Figure 2 shows the equivalent circuit of the VSP3200 and VSP3210 inputs.

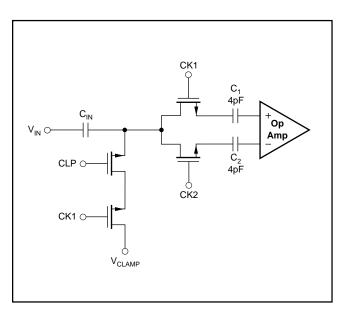


FIGURE 2. Equivalent Circuit of VSP3200 and VSP3210 Inputs.

In this equivalent circuit, Input Coupling Capacitor C_{IN} , and Sampling Capacitor C_1 , are constructed as a capacitor divider during CK1. For AC analysis, OP inputs are grounded. Therefore, the sampling voltage, V_S , during CK1 is:

$$V_S = (C_{IN}/(C_{IN} + C_1)) \cdot V_{IN}$$

From the above equation, we know that a larger C_{IN} makes V_S close to V_{IN} . In other words, the input signal (V_{IN}) will not be attenuated if C_{IN} is large.

However, there is a disadvantage of using a large C_{IN} : it will take longer for the CLP signal to charge up C_{IN} so that the input circuitry of the VSP3200 and VSP3210 can work properly.

CHOOSING C_{MAX} AND C_{MIN}

As mentioned before, a large C_{IN} is better if there is enough time for the CLP signal to charge up C_{IN} so that the input circuitry of the VSP3200 and VSP3210 can work properly. Typically, $0.01\mu F$ to $0.1\mu F$ of C_{IN} can be used for most cases.

In order to optimize C_{IN} , the following two equations can be used to calculate the maximum (C_{MAX}) and minimum (C_{MIN}) values of C_{IN} :

$$C_{MAX} = (t_{CK1} \cdot N)/[R_{SW} \cdot ln(V_D/V_{ERROR})]$$

where t_{CK1} is the time when both CK1 and CLP go HIGH, and N is the number of black pixels; R_{SW} is the switch resistance of the VSP3200 and VSP3210 (typically, driver impedance + $4k\Omega$); V_D is the droop voltage of C_{IN} ; V_{ERROR} is the voltage difference between V_S and V_{CLAMP} .

$$C_{MIN} = (II/V_{ERROR}) \cdot t$$

where II is the leakage current of the VSP3200 and VSP3210 input circuitry (10nA is a typical number for this leakage current); t is the clamp pulse period.

SETTING FOR FULL-SCALE INPUT RANGE

The input range of the internal 16-bit A/D converter can be set in two ways:

• Internal reference: to set the internal reference mode, D2 of the configuration register must be set to "0" and the reference voltage set through D1. The full-scale input voltage setting is twice the reference voltage. When the reference voltage is set at 1V (D1 = "0"), the full-scale voltage is 2Vp-p. However, when the reference voltage is set at 1.5V (D1 = "1"), the full-scale voltage is 3Vp-p. In internal reference mode, V_{REF} should be connected to GND with a 0.1μF capacitor. Do not use V_{REF} voltages in



other system circuits, as it would affect the reference voltage of the A/D converter and prevent proper A/D conversion.

• External Reference: to set the external reference mode, D2 of the configuration register must be set to "1". In external reference mode, V_{REF} operates as an analog voltage input pin. Inputting half the voltage necessary for the full-scale voltage range (e.g.: 1.7V applied for a necessary 3.4Vp-p input range), with a reference voltage range from 0.25V to 1.75V, will create the full-scale range. Thus, when V_{REF} is 0.5V, the full-scale range will be 0.5Vp-p, and when V_{REF} is 1.75V, the full-scale range will be 3.5Vp-p.

PROGRAMMING THE VSP3200 AND VSP3210

The VSP3200 and VSP3210 consist of three CCD channels and a 16-bit A/D. Each channel (Red, Green, and Blue) has its own 10-bit Offset and 6-bit Gain Adjustable Registers to be programmed by the user. There is also an 8-bit Configuration Register, on-chip, to program the different operation modes. Those registers are shown in Table III.

ADDRESS A2 A1 A0	REGISTER	POWER-ON DEFAULT VALUE
0 0 0	Configuration Register (8-bit)	All "0s"
0 0 1	Red Channel Offset Register (10-bit)	All "0s"
0 1 0	Green Channel Offset Register (10-bit)	All "0s"
0 1 1	Blue Channel Offset Register (10-bit)	All "0s"
1 0 0	Red Channel Gain Register (6-bit)	All "0s"
1 0 1	Green Channel Gain Register (6-bit)	All "0s"
1 1 0	Blue Channel Gain Register (6-bit)	All "0s"
1 1 1	Reserved	

TABLE III. On-Chip Registers.

These registers can be accessed by the following two programming modes:

- Parallel Programming Mode (VSP3200 only) using digital data output pins, with the data bus assigned as D0 to D9 (pins 25 to 34), and the address bus as A0 to A2 (pins 35 to 37). It can be used for both reading and writing operations. However, it cannot be used by the Demultiplexed mode (when D7 of the Configuration Register is set to "1").
- Serial Programming Mode using a serial port, Serial Data (SD), the Serial Shift Clock (SCLK), and Write Signal (WRT) assigned.

It can be used only for writing operations; reading operations via the serial port are prohibited.

Table IV shows how to access these modes (VSP3200 only).

ŌĒ	P/S	MODE
0	0	Digital data output enabled, Serial mode enabled
0	1	Prohibit mode (can not set this mode)
1	0	Digital data output disabled, Serial mode enabled
1	1	Digital data output disabled, Parallel mode enabled

TABLE IV. Access Mode for Serial and Parallel Port (VSP3200 Only).

CONFIGURATION REGISTER

The Configuration Register design is shown in Table V.

BIT	LOGIC '0'	LOGIC '1'	
D0	CCD mode	CIS mode	
D1	$V_{REF} = 1V$	V _{REF} =1.5V	
D2	Internal Reference	External Reference	
D3	3-channel Mode,	1-channel Mode,	
	D4 and D5 disabled	D4 and D5 enabled	
D4, D5	(disabled when 3-channel)	D4 D5	
		0 0 1-channel mode, Red channel	
		0 1 1-channel mode, Green channel	
		1 0 1-channel mode, Blue channel	
D6	MUX Sequence	MUX Sequence	
	Red > Green > Blue	Blue > Green >Red	
D7 ⁽¹⁾	Normal output mode	Demultiplexed output mode	

NOTE: (1) D7 of the configuration register should always be set to "1" for the VSP3210. Power-on default value is "0"; initial write operation for "1" is also needed for the VSP3210, when in power-on.

TABLE V. Configuration Register Design.

Power-on default value is all "0s", set to 3-Channel CCD mode with 1V internal reference, R > G > B MUX sequence, and normal output mode.

For reading/writing to the Configuration Register, the address will be A2 = "0", A1 = "0", and A0 = "0".

For Example:

A 3-Channel CCD with internal reference $V_{REF}=1V$ (2V full-scale input), R>G>B sequence and normal output mode will be D0 = "0", D1 = "0", D2 = "0", D3 = "0", D4 = "x (don't care)", D5 = "x (don't care)", D6 = "0", and D7 = "0".

For this example, bypass V_{REF} with an appropriate capacitor (e.g.:, $10\mu F$ to $0.1\mu F$) when internal reference mode is used.

Another Example:

A 1-Channel CCD mode (Green channel) with an external 1.2V reference (2.4V full-scale input), Demultiplexed Output mode will be D0 = "0", D1 = "x (don't care)", D2 = "1", D3 = "1", D4 = "0", D5 = "1", D6 = "x (don't care)", and D7 = "1".

For this example, V_{REF} will be an input pin applied with 1.2V.



OFFSET REGISTER

Offset Registers control the analog offset input to channels prior to the PGA. There is a 10-bit Offset Register on each channel. The offset range varies from -500 mV to +500 mV. The Offset Register uses a straight binary code. All "0s" corresponds to -500 mV, and all "1s" corresponds to +500 mV of the offset adjustment. The register code (200_{H}) corresponds to 0 mV of the offset adjustment. The Power-on default value of the Offset Register is all "0s", so the offset adjustment should be set to -500 mV.

PGA GAIN REGISTER

PGA Gain Registers control the gain to channels prior to the digitization by the A/D converter. There is a 6-bit PGA Gain Register on each channel. The gain range varies from 1 to 4.8 (from 0dB to 13dB). The PGA Gain Register is a straight binary code. All "0s" corresponds to an analog gain of 0dB, and all "1s" corresponds to an analog gain of 13dB. PGA Transfer function is log gain curve. Power-on default value is all "0s", so that it sets the gain of 0dB.

OFFSET AND GAIN CALIBRATION SEQUENCE

When the VSP3200 and VSP3210 are powered on, they will be initialized as 3-Channel CCDs, 1V internal reference mode (2V full-scale) with an analog gain of 1, and normal output mode. This mode is commonly used for CCD scanner applications. The calibration procedure is done at the very beginning of the scan.

To calibrate the VSP3200, use the following procedures:

- 1) Set the VSP3200 to the proper mode.
- 2) Set Offset to 0mV (control code: 00_H), and PGA gain to 1 (control code: 200_H).
- 3) Scan dark line.
- 4) Calculate the pixel offsets according to the A/D Converter output.
- 5) Readjust input Offset Registers.
- 6) Scan white line.
- Calculate gain. It will be the A/D Converter full-scale divided by the A/D Converter output when the white line is scanned.
- 8) Set the Gain Register. If the A/D Converter output is not close to full-scale, go back to item 3. Otherwise, the calibration is done.

The calibration procedure is started at the very beginning of the scan. Once calibration is done, registers on the VSP3200 will keep this information (offset and gain for each channel) during the operation.

RECOMMENDATION FOR POWER SUPPLY, GROUNDING, AND DEVICE DECOUPLING

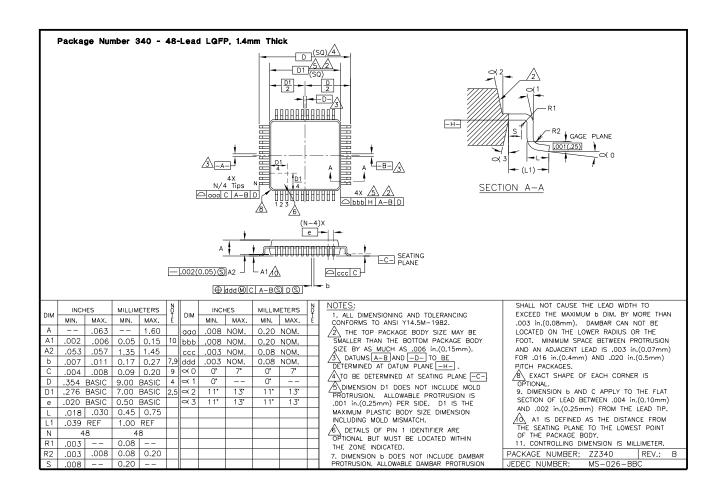
The VSP3200 and VSP3210 incorporate a very-high precision, high-speed A/D converter and analog circuitry vulnerable to any extraneous noise from the rails, etc. Therefore, it should be treated as an analog component and all supply pins, except V_{DRV} , should be powered by the only analog supply in the system. This will ensure the most consistent results, since digital power lines often carry high levels of wideband noise that otherwise would be coupled into the device and degrade the achievable performance.

Proper grounding, bypassing, short lead length, and the use of ground planes are particularly important for high-frequency designs. Multilayer PC boards are recommended for the best performance since they offer distinct advantages such as minimization of ground impedance, separation of signal layers by ground layers, etc.

It is recommended that all ground pins of the VSP3200 and VSP3210 be joined together at the IC and connected only to the analog ground of the system. The driver stage of the digital outputs (B[15:0]) is supplied through a dedicated supply pin, V_{DRV}, and should be completely separated from other supply pins with at least a ferrite bead. Keeping the capacitive loading on the output data lines as low as possible (typically less than 15pF) is also recommended. Larger capacitive loads demand higher charging current surges that can feed back into the analog portions of the VSP3200 and VSP3210, affecting device performance. If possible, external buffers or latches should be used, providing the added benefit of isolating the VSP3200 and VSP3210 from any digital noise activity on the data lines.

In addition, resistors in series with each data line may help minimize surge currents. Values in the range of 100Ω to 200Ω will limit the instantaneous current the output stage requires from recharging parasitic capacitances as output levels change from LOW to HIGH or HIGH to LOW. As the result of the high operation speed, the converter also generates high-frequency current transients and noises that are fed back into the supply and reference lines. This requires that the supply and reference pins be sufficiently bypassed. In most cases, $0.1\mu F$ ceramic chip capacitors are adequate in decoupling reference pins. Supply pins should be decoupled to the ground plane with a parallel combination of tantalum $(1\mu F$ to $22\mu F)$ and ceramic $(0.1\mu F)$ capacitors. Decoupling effectiveness largely depends upon the proximity to the individual pins.





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Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265